

#### **Description**

The DMT3020LSDQ-13 uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

# or in other Switching application. General Features

V<sub>DS</sub> = 30V I<sub>D</sub> = 8.5 A

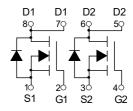
 $R_{DS(ON)} < 18m\Omega$  @  $V_{GS}=4.5V$ 

#### **Application**

Battery protection

Load switch

Uninterruptible power supply



SOP-8

(SO-8)

D1<sub>D1<sub>D2</sub></sub>

**Dual N-Channel MOSFET** 

#### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
DMT3020LSDQ-13	SOP-8(SO-8)	HXY MOSFET	3000

## Absolute Maximum Ratings@ $T_j$ =25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units	
V <sub>DS</sub>	Drain-Source Voltage	30	V	
V <sub>G</sub> S	Gate-Source Voltage	<u>+</u> 20	V	
ID@Ta=25°C	Drain Current, V <sub>GS</sub> @ 4.5V <sup>3</sup>	8.5	А	
I <sub>D</sub> @T <sub>A</sub> =70°C	Drain Current, V <sub>GS</sub> @ 4.5V <sup>3</sup>	5.8	А	
Ірм	Pulsed Drain Current <sup>1</sup>	37	А	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	1.5	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Rthj-a	Maximum Thermal Resistance, Junction-ambient <sup>3</sup>	85	°C/W	

#### Dual N-Channel Enhancement Mode MOSFET

## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0 $V$ , $I_D$ =250 $u$ A	30			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA	-	0.034		V/°C	
0	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =7A	15		18	mO	
R <sub>DS(ON)</sub>	Static Dialii-Source Off-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =4A	I	22	28	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2		2.5	V	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	VGS-VDS , ID -230UA		-5.8		mV/°C	
	Drain-Source Leakage Current	$V_{DS}$ =24V , $V_{GS}$ =0V , $T_J$ =25°C			1	uA	
I <sub>DSS</sub>		$V_{DS}$ =24V , $V_{GS}$ =0V , $T_{J}$ =55°C			5		
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =7A		6		S	
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.5		Ω	
Qg	Total Gate Charge (4.5V)			6			
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =7A		2.5		nC	
Q <sub>gd</sub>	Gate-Drain Charge			2.1			
T <sub>d(on)</sub>	Turn-On Delay Time			2.4			
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$		7.8		ns	
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =7A		22			
T <sub>f</sub>	Fall Time			4			
C <sub>iss</sub>	Input Capacitance			572			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		80		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			65			
Is	Continuous Source Current <sup>1,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			7.3	Α	
I <sub>SM</sub>	Pulsed Source Current <sup>2,5</sup>	VG-VB-0V , Force Current	-		37	Α	
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	$V_{GS}$ =0V , $I_{S}$ =1A , $T_{J}$ =25°C			1.2	V	
t <sub>rr</sub>	Reverse Recovery Time			20		nS	
Q <sub>rr</sub>	Reverse Recovery Charge	IF=7A,dI/dt=100A/µs,T <sub>J</sub> =25°C		1.1		nC	

<sup>1.</sup> The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper.

<sup>2.</sup>The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

<sup>3.</sup>The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH, $I_{AS}$ =21A

<sup>4.</sup> The power dissipation is limited by 150°C junction temperature

<sup>5.</sup> The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



## **Typical Characteristics**

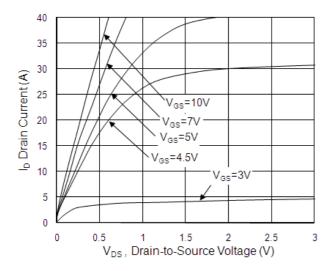


Fig.1 Typical Output Characteristics

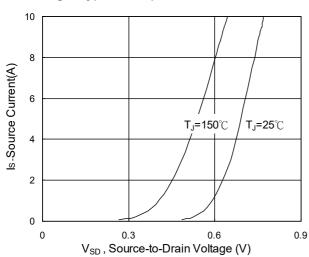


Fig.3 Forward Characteristics Of Reverse

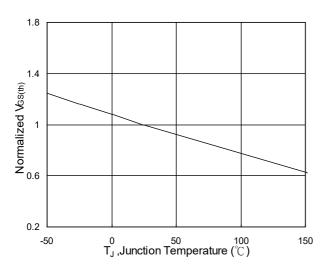


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

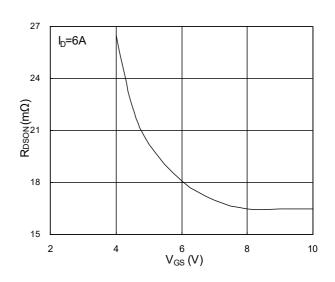


Fig.2 On-Resistance vs. G-S Voltage

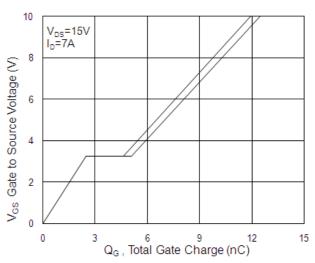


Fig.4 Gate-Charge Characteristics

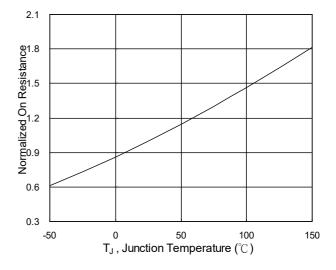
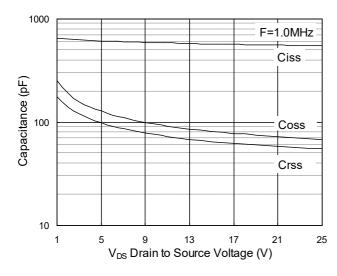


Fig.6 Normalized  $R_{DSON}$  vs.  $T_J$ 



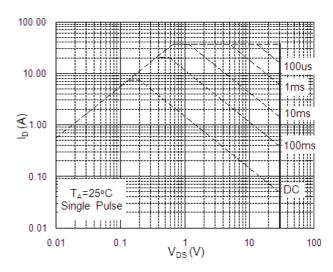


Fig.7 Capacitance

Fig.8 Safe Operating Area

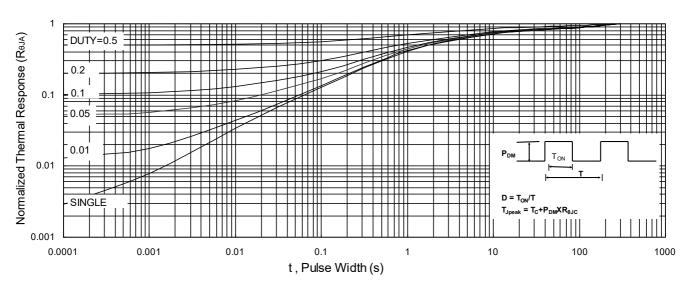


Fig.9 Normalized Maximum Transient Thermal Impedance

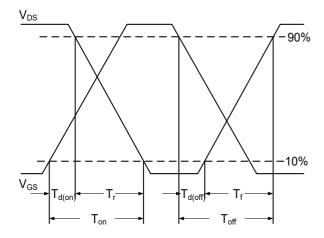


Fig.10 Switching Time Waveform

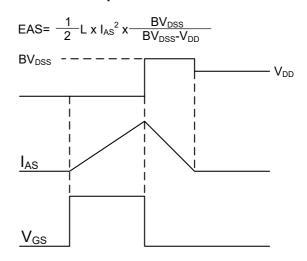
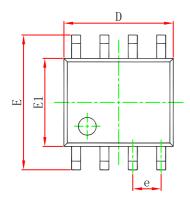
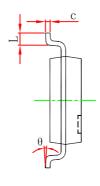
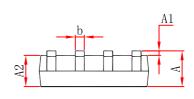


Fig.11 Unclamped Inductive Switching Waveform

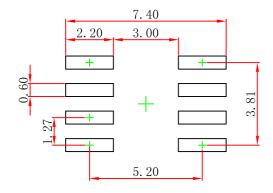
# SOP-8(SO-8) Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1. 350	1.750	0.053	0.069	
A1	0.100	0. 250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
c	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0. 197	
e	1.270 (BSC)		0.050 (BSC)		
E	5.800	6.200	0. 228	0. 244	
E1	3.800	4.000	0.150	0. 157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



- Note:
  1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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